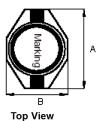
## **Inductor**

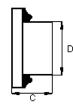
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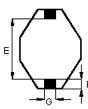


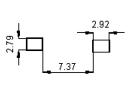
### **Configurations and Dimensions**





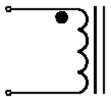
Side View





Bottom View Suggest PCB Layout

### **Schematic Diagram**



Note:

(1) Wire Ø0.08mm × 1P 2UEWF 155°C

Dimensions: Millimetres

(2) 200.5TS (Reference)

### **Test Data for Mechanical**

Test Item	A mm	B mm	C mm	D mm	E mm	F mm	G mm
Specification	12.95 (Max.)	9.5 (Max.)	5.2 (Max.)	8.4 ±0.3	7.62 (Ref.)	2.54 (Ref.)	2.54 (Ref.)
Specification	` ′	` ′	· · · · · · ·		`	` `	`
1	12.78	9.21	4.78	8.49	7.62	2.52	2.53
2	12.74	9.22	4.8	8.48	7.6	2.51	2.52
3	12.78	9.2	4.81	8.5	7.62	2.51	2.53
4	12.78	9.18	4.82	8.52	7.62	2.5	2.51
5	12.74	9.2	4.79	8.49	7.59	2.52	2.52
Average	12.76	9.2	4.8	8.5	7.61	2.51	2.52

### **Electrical Characteristics**

Test Condition		
100kHz 0.1V	L	1mH ±10%
at 25°C	DCR	10.3Ω (Max.)
100kHz 0.1V Irms = 0.28A	L at Irms	ΔT 40°C (Max.)

Operating temperature : -55°C to +130°C Note : Irms : Temperature rise 40°C

#### **Material List**

No.	Item Material Description	
1	Core	R5A DR4.8 × 4; R5A RI 8.4 × 4.1 × 6.85
2	Wire	Ø0.08mm × 1P 2UEWF (155°C)
3	Solder (Lead Free)	Sn99.3% / Cu0.7%
4	Glue	TH320D / TH320-3
5	Base	SN-BS019.01 LCP

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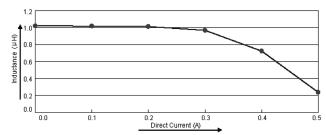
## **Inductor**

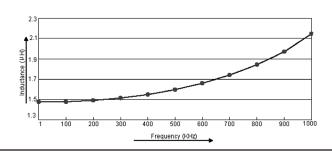


### **Reliability Test**

Test Item	Specifications	Test Method and Remarks
Solderability	The electrodes shall be at least 90% covered with new solder coating.	According to IEC68-2-20 Soldering temperature : 245 ±5°C Solder : Sn99.3% / Cu0.7% Flux : Rosin Immersion time : 5 ±1s
Soldering heat resistance	Appearance : No damage Inductance change : Within ±10% of initial value	Preheat temperature 150°C Preheat time : 1 min Solder temperature : 260 ±5°C Dipping time : 10 ±1s Measured at room temperature after placing for 24 hours.
Vibration (Out LAB)	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to MIL-STD202 Method 204 Frequency : 10 to 55 Hz Amplitude : 1.52mm Direction and time X Y and Z direction for 2 hours each.
Humidity resistance test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-1 Method Ca Temperature : 40 ±2°C Humidity : 90%-95% RH Test time : 500 ±2hrs The component should be stabilized at normal condition for 24 hours before test.
High temperature resistance test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-2 Temperature : 85 ±3°C Test time : 500 +24 hrs The component should be stabilized at normal condition for 24 hours before test.
Low temperature resistance test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-1 Method A (Ad) Temperature : -40 ±3°C Test time : 500 +24hrs The component should be stabilized at normal condition for 24 hours before test.
Temperature cycles test	Appearance : No damage All electrical and mechanical parameters within tolerance.	According to IEC68-2-14 Method N (Nb) High-temperature : 85 ±3°C duration 30 mins Room-temperature : 25 ±2°C duration 3 hrs Low-temperature : -40 ±3°C duration 30 mins Room-temperature : 25 ±2°C duration 3 hrs Number of cycle : 10 cycles The component should be stabilized at normal condition for 24 hours before test.

### **Electric Characteristics**





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### Inductor



### **Test Data for Electrical**

Test Item	L µH	DCR Ω	L at Irms mH
Condition	100kHz 0.1V	at 25°C	100kHz 0.1V Irms = 0.28A
Specification	1 ±10%	10.3 (Max.)	ΔT 40°C (Max.)
1	1.024	8.128	
2	1.018	8.058	
3	1.012	8.135	OK
4	1.023	8.068	
5	1.015	8.085	
Average	1.018	8.095	OK

#### **Part Number Table**

Description	Part Number	
Inductor, 1MH, 10%, SMD	MCBFS5220-102KU	

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